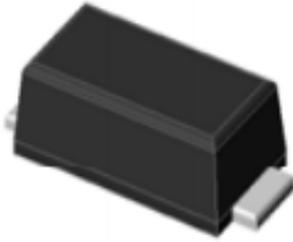


**Surface Mount Glass Passivated Fast Recovery Rectifier**
**SOD-123FL(eSGA)**

**Features**

- ROHS compliant
- Glass passivated chip
- High forward surge capability
- Meet MSL level 1, per J-STD-020 LF maximum peak of 250 °C
- Solder dip 260 °C / 40S
- Component in accordance to ROHS 2002/95/EC and WEEE 2002/96/WC
- UL recognition, file number E342874


**Primary characteristics**

$I_{F(AV)}$	1.2A
$V_{RRM}$	50~1000V
$I_{FSM}$	50A
$I_{RM}$	5 $\mu$ A
$V_{FM}$ at $I_F=1.2A$	1.3V
$T_J$ max.	150 °C

**Applications**

Ideal for ac-to-dc bridge full wave rectification such as SMPS, home appliances, office equipment, industrial automation applications

**Mechanical data**

- SOD-123FL(eSGA)
- Epoxy meets UL 94 V-0 flammability rating
- Terminals: Tin plated leads.
- Polarity: As marked.
- Mounting Torque:10cm·kg(8.8 inches·lbs)max.
- Recommended Torque:5.7 cm·kg(5 inches·lbs)

**Maximum rating (Ta=25°C unless otherwise noted)**

Parameter	Sym	SOD-123FL(eSGA)							Unit
		RS1205FL	RS1201FL	RS1202FL	RS1204FL	RS1206FL	RS1208FL	RS1210FL	
Max. repetitive peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V
Max. RMS reverse voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Max. DC blocking voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Max. average forward current	$I_{F(AV)}$	1.2							A
Non-repetitive peak forward surge current 8.3ms single half-sine-wave	$I_{FSM}$	50							A
Max. instantaneous forward voltage drop per diode	$V_{FM}$	1.3 (1.2A)							V
Max. instantaneous reverse current at rated DC blocking voltage	$I_{RM}$	5							$\mu$ A
		50							
Operating junction temperature	$T_J$	-55 ~ +150							°C
Storage temperature	$T_{STG}$	-55 ~ +150							°C
Maximum reverse recovery time (Note2)	trr	150			250	500		nS	
Typical thermal resistance (Note1)	R J-A	67							°C/W
	R J-M	3.3							
	R J-C	25							

**Notes:**

1 Mounted on PCB with 5.0x5.0mm copper pads,2 OZ,FR4 PCB

2. Reverse recovery test conditions:  $I_F=0.5A$ ,  $I_R=1.0A$ ,  $I_{rr}=0.25A$



Ordering information (Example)

PREFERRED	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
RS1210FL				

Typical characteristics

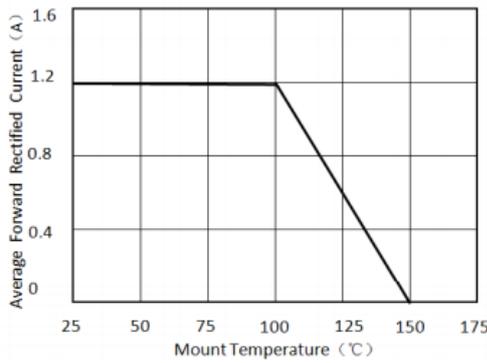


Figure 1. Forward Current Derating Curve

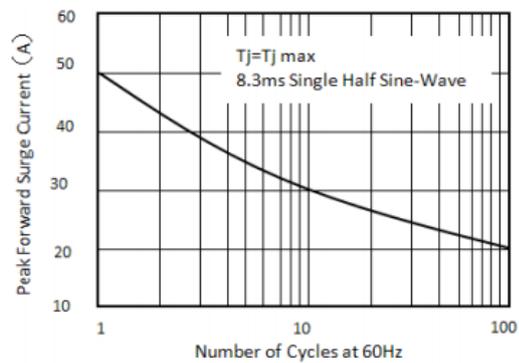


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

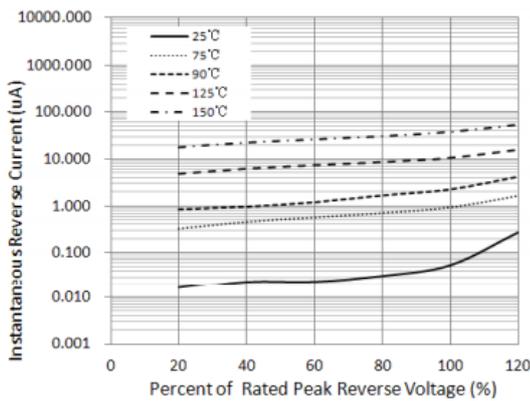


Figure 3. Typical Reverse Characteristics

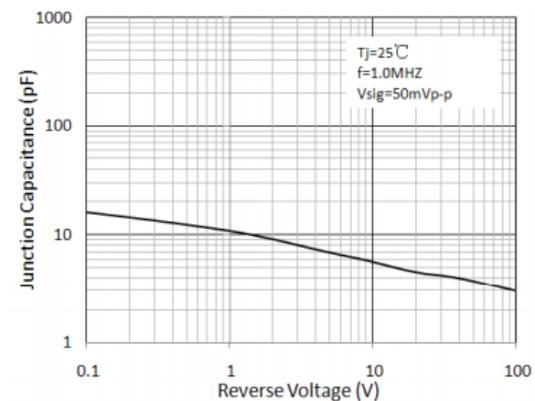
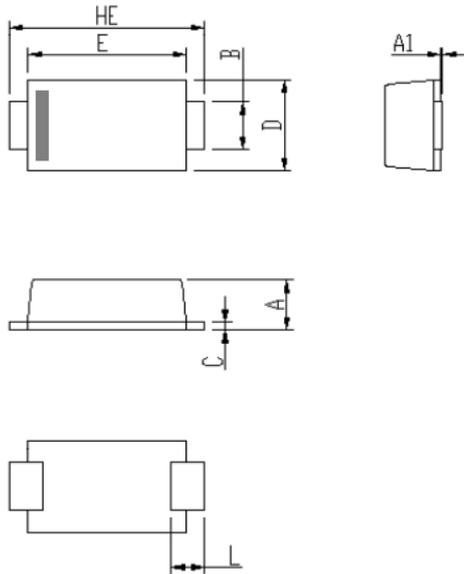


Figure 4. Typical Junction Capacitance

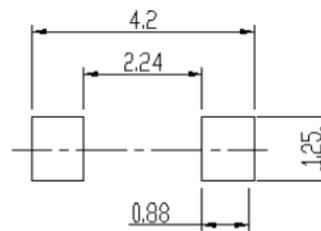
**Package outline dimensions**

in inches (millimeters)



DIM	Unit: mm		Unit: inch	
	MIN	MAX	MIN	MAX
A	0.9	1.08	0.035	0.043
A1	0	0.1	0.000	0.004
B	0.85	1.05	0.033	0.041
C	0.1	0.25	0.004	0.010
D	1.7	2	0.067	0.079
E	2.9	3.1	0.114	0.122
L	0.43	0.83	0.017	0.033
HE	3.5	3.9	0.138	0.154

Soldering footprint



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